Date : 5/19/2021 Doc. No.: 5021004 Teruhiro Koshiba General Manager LED Division ROHM Co.,LTD

## **Product/Process Change Notification**

Dear Customer,

US Distribution Partners

This is an announcement of change(s) to the process being used for the products currently supplied. We request your acknowledgement to receive this notification within the given period.

Please reply by: $6/7/2021$								
Title of change	Request for conversion of products using CREE chips to products using in-house chips							
		Product nar		Customer part number				
Affected product(s)	Attached is a sep	arate sheet.		Attached is a separate sheet.				
		Now		After				
Detailed description of change	CREE chip			in-house chip				
Reason for change	Since there is no prospect of resolving the supply problem of CREE chips Therefore, we would like to propose a change to a chips manufactured in our factory with similar characteristics.							
Anticipated impact on quality	(form, fit, function, reliability) All of the products that we propose using in-house chips will comply with the same reliability test evaluation items as the current products. All of the proposed products using ROHM chips will be transferred to mass production in compliance with the same reliability test evaluation items as the current products, and the products will be supplied.							
Identification of change	5 ,							
<u> </u>					Sample availab	e schedule	ttached is a separate sheet	
Attachements (data, report) YES Attached is a separate sheet.   Depending on the development status of our chips, we will classify the changes into four categories and proceed. ①This is a switch to a product that has already been mass-produced. Samples are available at any time.   Comments ②Development product A Product with the same PKG and land pattern: We will start up according to the development schedule.   ③ Development product B: Same land pattern, but different PKG structure: We will start up according to the development schedule.   ④ OSAT products Lamp general products: We will develop OSAT products at Lighten using in-house made chips.								
Reply to Nam		chi.Terashima	Title	Group Lea		E-mail	shoichi.terashima@mnf.rom.co	
Dep	artment	Module	Quality Control	Dept QCIC	1	Tel	81-75-321-4352	
				Reply	date			
Customer reply	1. Appro		2. Acce	epted with c	onditions.	3.	Rejected.	
Condition for approval / reason for rejection								
Comments								
Customer company name								
Customer sign	ature		Departme	Department				
Customer signature					Department			
RGTSZ22402 · 10 · 001								

Rohm P/N SMLE13WBC8W1H CSL0406WBCW10 SML312BC4TT86 SML312ECTT86 SML312WBCW14A SMLA12WBC7W1H SMLE12BC7TT86 SMLE12WBC7W1A SMLE13BC8TT86 SMLE13EC8TT86 SMLE13WBC8W1A SMLP34RGB2W3 SMLP36RGB2W3R SML522BU1WT86 SML813WBC8W1A SMLK18WBJAW10 SMLK18WBJCW10 SMLK28WBJCW10 SMLP13EC8TT86 SMLP36RGB2W3 SMLZ13BDTT86A SLR343WBD2PT21 SML312WBCW10A SML312WBCW11A SMLA13BDTT86 SLR343BC4T3F SLR343ECT3F SLR343WBD2PT31 SLR343WBD2PT3 SML012BC4TT86 SML012ECTT86 SML813WBC8W1H SMLA12WBC7W1K SMLE12EC6TT86 CSL0406WBCW13 SML013BDTT86 SMLE12WBC7W1K CSL0406WBCW11